1M x 4 Bit Static Random Access Memory

The MCM6249 is a 4,194,304 bit static random access memory organized as 1,048,576 words of 4 bits, fabricated using high–performance silicon–gate CMOS technology. Static design eliminates the need for external clocks or timing strobes, while CMOS circuitry reduces power consumption and provides for greater reliability.

The MCM6249 is equipped with chip enable (\overline{E}) and output enable (\overline{G}) pins, allowing for greater system flexibility and eliminating bus contention problems. Either input, when high, will force the outputs into high impedance.

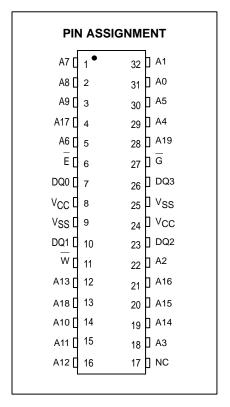
The MCM6249 is available in a 400 mil, 32-lead surface-mount SOJ package.

- Single 5 V ± 10% Power Supply
- Fast Access Time: 20/25/35 ns
- Equal Address and Chip Enable Access Time
- · All Inputs and Outputs are TTL Compatible
- Three-State Outputs
- Power Operation: 190/175/160 mA Maximum, Active AC

BLOCK DIAGRAM A13 A12 A11 A10 A9 MEMORY MATRIX ROW 1024 ROWS x DECODER **A8** 4096 COLUMNS Α7 A6 A5 A4 COLUMN I/O DQ0 INPUT COLUMN DECODER DATA CONTROL DQ3 A17 A16 A15 A14 A19 DQ0 W DQ3

MCM6249





<u>A0</u> − A19 Address Inputs <u>W</u> Write Enable G Output Enable
E

REV 4 5/95



TRUTH TABLE (X = Don't Care)

Е	G	w	Mode	I/O Pin Cycle		Current
Н	Х	Х	Not Selected	High-Z —		I _{SB1} , I _{SB2}
L	Н	Н	Output Disabled	High–Z	_	ICCA
L	L	Н	Read	D _{out}	Read	ICCA
L	Х	L	Write	High-Z	Write	ICCA

ABSOLUTE MAXIMUM RATINGS (See Note)

Rating	Symbol	Value	Unit
Power Supply Voltage Relative to VSS	Vcc	- 0.5 to + 7.0	V
Voltage Relative to VSS for Any Pin Except VCC	V _{in} , V _{out}	- 0.5 to V _{CC} + 0.5	>
Output Current (per I/O)	l _{out}	± 20	mA
Power Dissipation	PD	1.0	W
Temperature Under Bias	T _{bias}	- 10 to + 85	°C
Operating Temperature	TA	0 to + 70	°C
Storage Temperature — Plastic	T _{stg}	- 55 to + 150	°C

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPER-ATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to these high impedance circuits.

This CMOS memory circuit has been designed to meet the dc and ac specifications shown in the tables, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow of at least 500 linear feet per minute is maintained.

DC OPERATING CONDITIONS AND CHARACTERISTICS

(V_{CC} = $5.0 \text{ V} \pm 10\%$, T_A = $0 \text{ to} + 70^{\circ}\text{C}$, Unless Otherwise Noted)

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage (Operating Voltage Range)	Vcc	4.5	5.0	5.5	V
Input High Voltage	VIH	2.2	_	V _{CC} + 0.3	V
Input Low Voltage	V _{IL}	- 0.5*	_	0.8	V

^{*}V_{IL} (min) = -0.5 V dc; $\overline{V_{IL}}$ (min) = -2.0 \overline{V} ac (pulse width ≤ 2.0 ns).

DC CHARACTERISTICS

Parameter	Symbol	Min	Max	Unit
Input Leakage Current (All Inputs, V _{in} = 0 to V _{CC})	l _{lkg(l)}	_	± 1.0	μΑ
Output Leakage Current (E = V_{IH} , V_{Out} = 0 to V_{CC})	llkg(O)	_	± 1.0	μΑ
Output Low Voltage (I _{OL} = + 8.0 mA)	VoL	_	0.4	V
Output High Voltage (I _{OH} = - 4.0 mA)	Voн	2.4	_	V

POWER SUPPLY CURRENTS

Paramete	Symbol	Min	Тур	Max	Unit	
AC Active Supply Current (I _{Out} = 0 mA, V _{CC} = max)	MCM6249–20: t_{AVAV} = 20 ns MCM6249–25: t_{AVAV} = 25 ns MCM6249–35: t_{AVAV} = 35 ns	ICC	_ _ _	175 160 145	190 175 160	mA
AC_Standby Current (V _{CC} = max, E = V _{IH} , No other restrictions on other inputs)	MCM6249–20: t_{AVAV} = 20 ns MCM6249–25: t_{AVAV} = 25 ns MCM6249–35: t_{AVAV} = 35 ns	I _{SB1}	_ _ _	50 40 35	60 50 40	mA
CMOS Standby Current (E \geq V _{CC} - 0.2 \leq V _{CC} - 0.2 V) (V _{CC} = max, f = 0 MH:	I _{SB2}	_	10	15	mA	

MCM6249 MOTOROLA FAST SRAM

CAPACITANCE (f = 1.0 MHz, dV = 3.0 V, T_A = 25°C, Periodically Sampled Rather Than 100% Tested)

	Symbol	Тур	Max	Unit	
Input Capacitance	All Inputs Except Clocks a <u>nd DQs</u> E, G, W	C _{in} C _{ck}	4 5	6 8	pF
Input/Output Capacitance	DQ	C _{I/O}	5	8	pF

AC OPERATING CONDITIONS AND CHARACTERISTICS

(V_{CC} = 5.0 V \pm 10%, T_A = 0 to + 70°C, Unless Otherwise Noted)

Input Pulse Levels 0 to 3.0 V	Output Timing Measurement Reference Level 1.5 V
Input Rise/Fall Time	Output Load See Figure 1a
Input Timing Measurement Reference Level 1.5 V	

READ CYCLE TIMING (See Note 1)

		мсм6	249–20	MCM6249-25		MCM6249-25 MCM6249-35			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read Cycle Time	t _{AVAV}	20		25	_	35	_	ns	2, 3
Address Access Time	tAVQV	_	20	_	25	_	35	ns	
Enable Access Time	t _{ELQV}	_	20	_	25	_	35	ns	4
Output Enable Access Time	tGLQV	_	6	_	8	_	10	ns	
Output Hold from Address Change	tAXQX	5		5	_	5	_	ns	
Enable Low to Output Active	tELQX	5		5	_	5	_	ns	5, 6, 7
Output Enable Low to Output Active	tGLQX	0		0	_	0	_	ns	5, 6, 7
Enable High to Output High–Z	t _{EHQZ}	0	9	0	10	0	12	ns	5, 6, 7
Output Enable High to Output High–Z	^t GHQZ	0	9	0	10	0	12	ns	5, 6, 7
Power Up Time	^t ELICCH	0	_	0	_	0	_	ns	
Power Down Time	^t EHICCL	_	20	_	25	_	35	ns	

NOTES:

- 1. W is high for read cycle.
- Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.
- 3. All read cycle timings are referenced from the last valid address to the first transitioning address.
- 4. Addresses valid prior to or coincident with E going low/E going high.
- 5. At any given voltage and temperature, t_{EHQZ} max < t_{ELQX} min, and t_{GHQZ} max < t_{GLQX} min, both for a given device and from device to device.
- 6. Transition is measured \pm 500 mV from steady–state voltage with load of Figure 1b.
- 7. This parameter is sampled and not 100% tested.
- 8. Device is continuously selected ($E \le V_{IL}$, $G \le V_{IL}$).

OUTPUT = $Z_0 = 50 \Omega$ = $Z_0 = 50 \Omega$

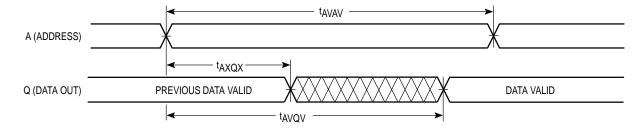
TIMING LIMITS

The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time. On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.

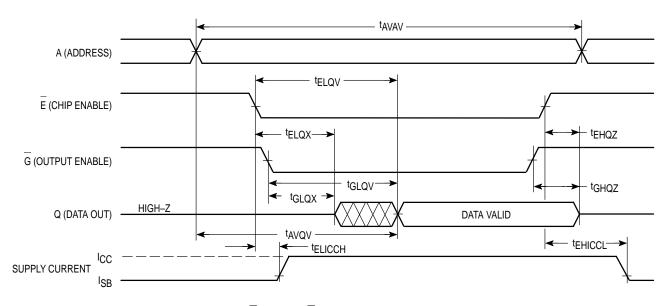
Figure 1. AC Test Loads

MOTOROLA FAST SRAM MCM6249

READ CYCLE 1 (See Note 8)



READ CYCLE 2 (See Note)



NOTE: Addresses valid prior to or coincident with E going low/E going high.

MCM6249 MOTOROLA FAST SRAM

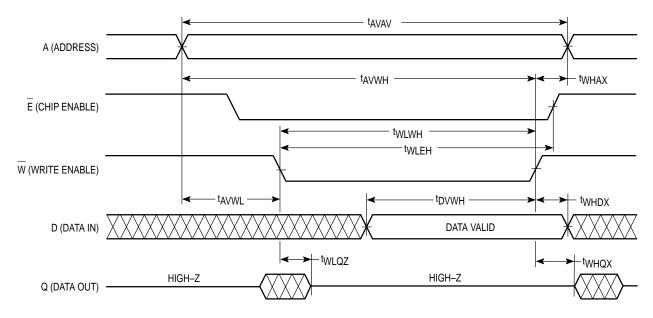
WRITE CYCLE 1 (W Controlled, See Notes 1, 2, and 3)

		мсм6	249–20	MCM6249-25		MCM6249-25 MCM6249-35			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	t _{AVAV}	20	_	25	_	35	_	ns	4
Address Setup Time	tAVWL	0	_	0	_	0	_	ns	
Address Valid to End of Write	^t AVWH	15	_	17	_	20	_	ns	
Write Pulse Width	tWLWH,	15	_	17	_	20	_	ns	
Data Valid to End of Write	tDVWH	10	_	10	_	15	_	ns	
Data Hold Time	tWHDX	0	_	0	_	0	_	ns	
Write Low to Data High–Z	tWLQZ	0	9	0	10	0	15	ns	5,6,7
Write High to Output Active	tWHQX	5	_	5	_	5	_	ns	5,6,7
Write Recovery Time	tWHAX	0	_	0	_	0	_	ns	

NOTES:

- 1. A write occurs during the overlap of E low and W low.
- 2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.
- 3. If G goes low coincident with or after W goes low, the output will remain in a high-impedance state.
- 4. All write cycle timings are referenced from the last valid address to the first transitioning address.
- 5. Transition is measured $\pm\,500$ mV from steady–state voltage with load of Figure 1b.
- 6. This parameter is sampled and not 100% tested.
- 7. At any given voltage and temperature, tWLQZ max < tWHQX min both for a given device and from device to device.

WRITE CYCLE 1 (W Controlled, See Notes 1, 2, and 3)



MOTOROLA FAST SRAM

MCM6249

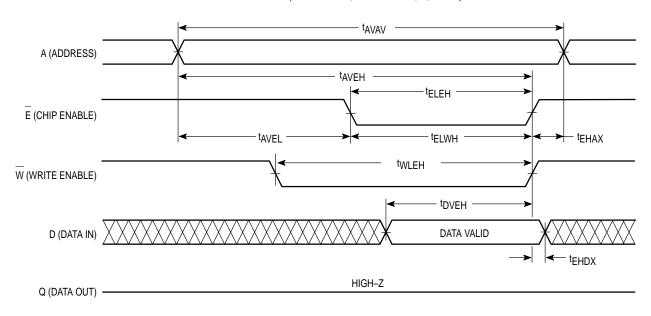
WRITE CYCLE 2 (E Controlled, See Notes 1, 2, and 3)

		мсм6	249–20	MCM6249-25		MCM6249-25 MCM6249-35			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	t _{AVAV}	20	_	25	_	35	_	ns	4
Address Setup Time	^t AVEL	0	_	0	_	0	_	ns	
Address Valid to End of Write	^t AVEH	15	_	17	_	20	_	ns	
Enable Pulse Width	^t ELEH, ^t ELWH	15	_	17	_	20	_	ns	5,6
Write Pulse Width	tWLEH	15	_	17	_	20	_	ns	
Data Valid to End of Write	^t DVEH	10	_	10	_	15	_	ns	
Data Hold Time	tEHDX	0	_	0	_	0	_	ns	
Write Recovery Time	^t EHAX	0	_	0	_	0	_	ns	

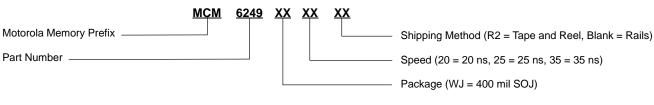
NOTES:

- 1. A write occurs during the overlap of E low and W low.
- 2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.
- 3. If G goes low coincident with or after W goes low, the output will remain in a high-impedance state.
- 4. All write cycle timing is referenced from the last valid address to the first transitioning address.
- 5. If E goes low coincident with or after W goes low, the output will remain in a high impedance condition.
- 6. If E goes high coincident with or before W goes high, the output will remain in a high impedance condition.

WRITE CYCLE 2 (E Controlled, See Notes 1, 2, and 3)



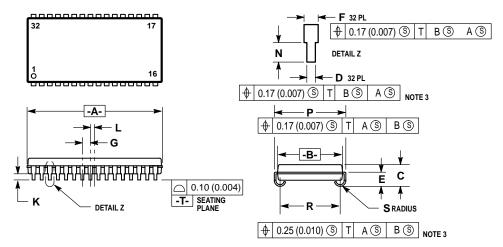
ORDERING INFORMATION (Order by Full Part Number)



Full Part Numbers — MCM6249WJ20 MCM6249WJ20R2 MCM6249WJ25 MCM6249WJ25R2 MCM6249WJ35R2

PACKAGE DIMENSIONS

WJ PACKAGE 400 MIL SOJ **CASE 857A-02**



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- 3
- TO BE DETERMINED AT PLANE -T-.
 DIMENSION A & B DO NOT INCLUDE MOLD PROTRUSION, MOLD PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION A & B INCLUDE MOLD MISMATCH AND ARE DETERMINED AT THE PARTING LINE.
- 857A-01 IS OBSOLETE, NEW STANDARD 857A-02.

	MILLIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	20.83	21.08	0.820	0.830
В	10.03	10.29	0.395	0.405
С	3.26	3.75	0.128	0.148
D	0.41	0.50	0.016	0.020
E	2.24	2.48	0.088	0.098
F	0.67	0.81	0.026	0.032
G	1.27	BSC	0.050	BSC
K	0.89	1.14	0.035	0.045
L	0.64	BSC	0.02	5 BSC
N	0.76	1.14	0.030	0.045
Р	11.05	11.30	0.435	0.445
R	9.27	9.52	0.365	0.375
S	0.77	1.01	0.030	0.040

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